Ordering number : EN4868A

CMOS LSI

LC7872E

CD Graphics Decoder

Overview

The LC7872E is a CMOS LSI that integrates in a single chip the signal processing functions required for compact disk graphics (CD-G) decoding. The LC7872E accepts the subcode R to W signals output by a CD-DSP chip such as the Sanyo LC786X series, LC7862XE series or LC7863XE series and performs de-interleaving, error detection and correction, graphics instruction processing and image processing.

Functions

- Built-in RGB encoder allows a CD-G decoder to be implemented in just two chips: the LC7872E and an external 64-kword × 4-bit DRAM
- Interpolation and protection for the CD subcode synchronization signals as well as de-interleaving, error detection and correction for the R to W signals.
- Two crystal oscillator systems, one for NTSC and one for PAL are provided and can be switched easily using the control pin provided. The standard clock and all required internal timings can be generated by connecting a 14.31818 MHz crystal for NTSC and/or a 17.734476 MHz crystal for PAL.
- The LC7872E performs CD graphics instruction processing and drawing processing and controls the image display.
- Composition video 8-bit D/A converter output provided
- Superimposition support
- Microprocessor interface provided to support set upgrades.
- Define transparency support
- Color bar output function

- **CCB is a trademark of SANYO ELECTRIC CO., LTD.**
- **CCB is SANYO's original bus format and all the bus addresses are controlled by SANYO.**

Features

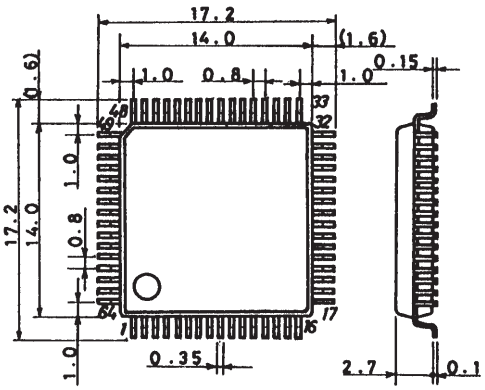
- A CD-G decoder can be implemented with just two chips: a controller is not required.
- Silicon gate CMOS structure for low power operation
- Single 5 V power supply
- 64-pin QFP (QIP) package

Package Dimensions

unit: mm

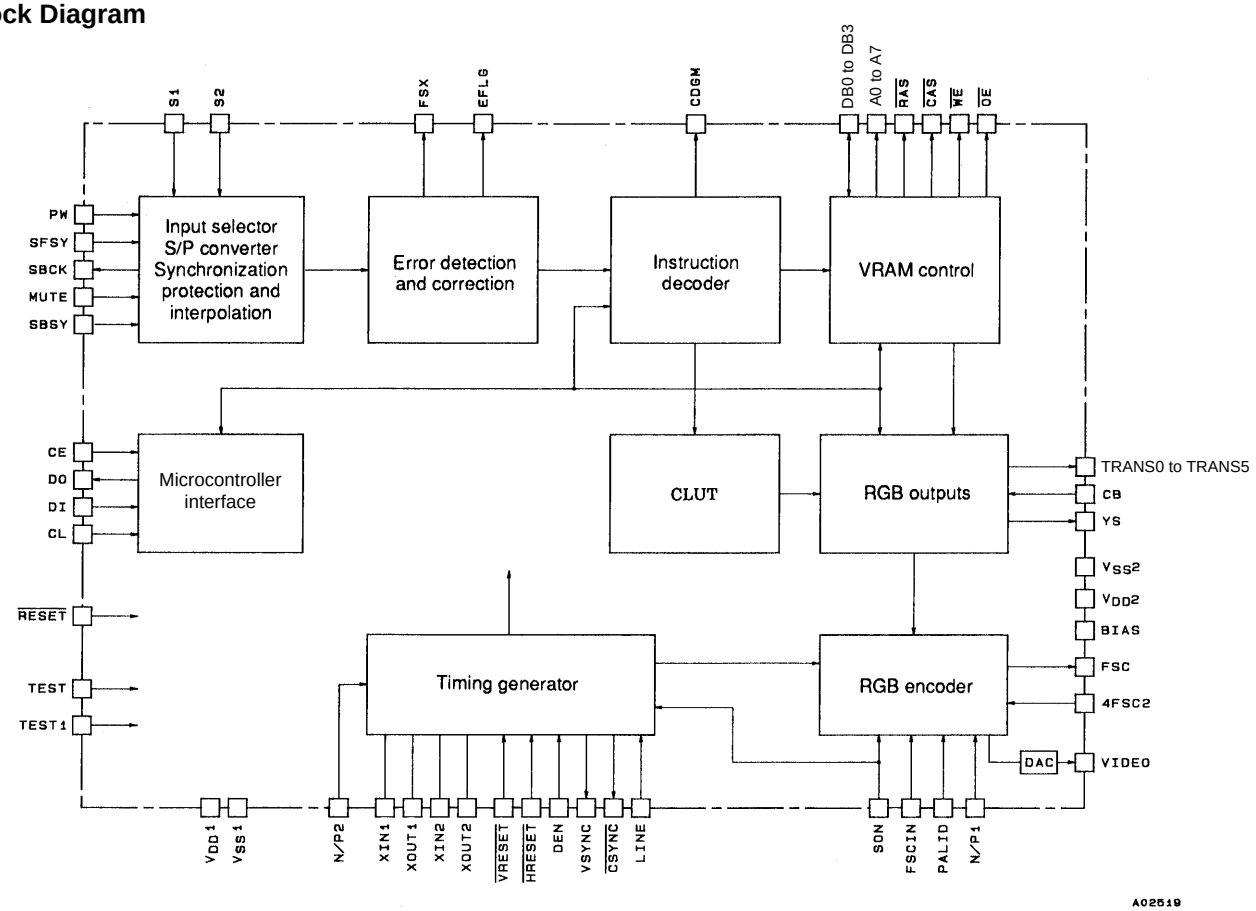
3159-QFP64E

[LC7872E]

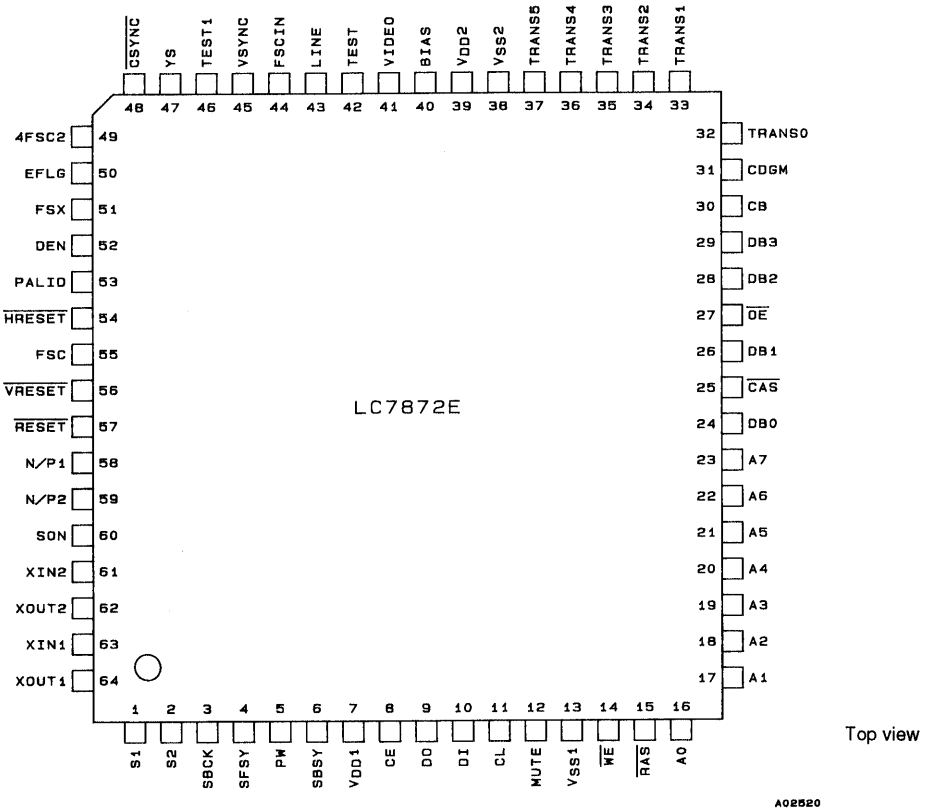


SANYO: QFP64E

Block Diagram



Pin Assignment



Specifications

Absolute Maximum Ratings at Ta = 25°C, V_{SS} = 0 V

Parameter	Symbol	Conditions	Ratings	Unit
Maximum supply voltage	V_{DD} max		V_{SS} – 0.3 to +7.0	V
Maximum input voltage	V_{IN} max		V_{SS} – 0.3 to V_{DD} + 0.3	V
Maximum output voltage	V_{OUT} max		V_{SS} – 0.3 to V_{DD} + 0.3	V
Allowable power dissipation	Pd max		300	mW
Operating temperature	Topr		–30 to +85	°C
Storage temperature	Tstg		–40 to +125	°C

Allowable Operating Ranges at Ta = 25°C, V_{SS} = 0 V

Parameter	Symbol	Conditions		min	typ	max	Unit
Supply voltage	V_{DD}	$V_{DD}1$, $V_{DD}2$		4.5		5.5	V
Input high level voltage	V_{IH} (1)	$\overline{\text{RESET}}$		0.7 V_{DD}		V_{DD}	V
	V_{IH} (2)	SFSY, PW, SBSY, CE, DI, CL, MUTE, DB0 to DB3, PALID, $\overline{\text{HRESET}}$, $\overline{\text{VRESET}}$, N/P1, N/P2, SON		2.2		V_{DD}	V
	V_{IH} (3)	S1, S2, CB, TEST, TEST1, LINE, DEN		0.8 V_{DD}		V_{DD}	V
Input low level voltage	V_{IL} (1)	$\overline{\text{RESET}}$		V_{SS}		0.3 V_{DD}	V
	V_{IL} (2)	SFSY, PW, SBSY, CE, DI, CL, MUTE, DB0 to DB3, PALID, $\overline{\text{HRESET}}$, $\overline{\text{VRESET}}$, N/P1, N/P2, SON		V_{SS}		0.8	V
	V_{IL} (3)	S1, S2, CB, TEST, TEST1, LINE, DEN		V_{SS}		0.2 V_{DD}	V
High level clock pulse width	$t_{øH}$	CL: Figure 1		400			ns
Low level clock pulse width	$t_{øL}$	CL: Figure 1		400			ns
Data setup time	t_{DS}	CL, DI: Figure 1		200			ns
Data hold time	t_{DH}	CL, DI: Figure 1		200			ns
CE wait time	t_{CP}	CE, CL: Figure 1		400			ns
CE setup time	t_{CS}	CE, CL: Figure 1		400			ns
CE hold time	t_{CH}	CE, CL: Figure 1		400			ns
DO setup time	t_{DOS}	CL, DO: Figure 1		130		300	ns
Input frequency	fin (1)	XIN1			14.31818		MHz
	fin (2)	XIN2			17.734476		MHz
	fin (3)	4FSC2	NTSC mode		14.31818		MHz
			PAL mode		17.734476		MHz
	fin (4)	FSCIN	NTSC mode		3.58		MHz
			PAL mode		4.43		MHz
Input amplitude	V_{IN}	XIN1, XIN2, 4FSC2, FSCIN: sine wave, capacitive coupling		0.3		5	Vp-p
Reset pulse width	t_{WRES}	RESET		400			ns

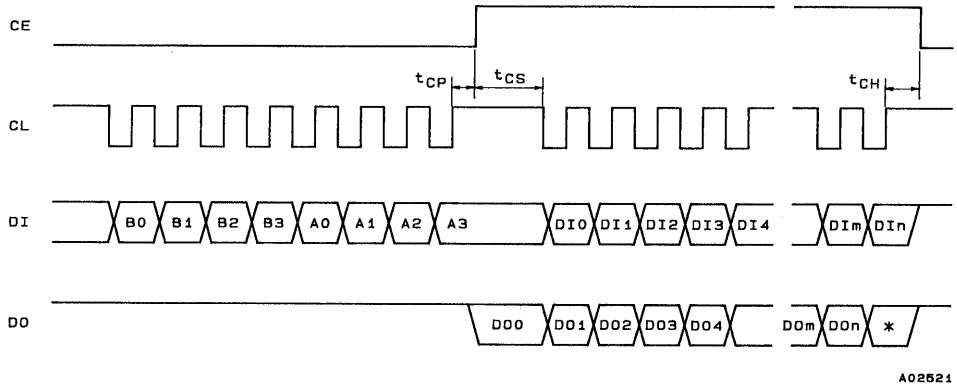
Electrical Characteristics at Ta = 25°C, V_{SS} = 0 V, V_{DD} = 5 V

Parameter	Symbol	Conditions	min	typ	max	Unit
Current drain	I_{DD} (1)	$V_{DD}1$		24	40	mA
	I_{DD} (2)	$V_{DD}2$		12	20	mA
Input high level current	I_{IH} (1)	S1, S2, SFSY, PW, SBSY, CE, DI, CL, MUTE, LINE, $\overline{\text{HRESET}}$, $\overline{\text{VRESET}}$, N/P1, N/P2, $\overline{\text{RESET}}$, SON: V_{IN} = V_{DD}			5	µA
	I_{IH} (2)	CB, TEST, TEST1, DEN: V_{IN} = V_{DD}	30	100	200	µA
Input low level current	V_{IL} (1)	S1, S2, SFSY, PW, SBSY, CE, DI, CL, MUTE, LINE, $\overline{\text{HRESET}}$, $\overline{\text{VRESET}}$, N/P1, N/P2, $\overline{\text{RESET}}$, SON: V_{IN} = V_{SS}	–5			µA
	V_{IL} (2)	PALID: V_{IN} = V_{SS}	–200	–100	–30	µA
Output high level voltage	V_{OH}	SBCK, $\overline{\text{WE}}$, $\overline{\text{RAS}}$, $\overline{\text{CAS}}$, $\overline{\text{OE}}$, A0 to A7, DB0 to DB3, CDGM, TRANS0 to TRANS5, VSYNC, YS, $\overline{\text{CSYNC}}$, EFLG, FSX, FSC: I_O = –0.5 mA	V_{DD} – 1		V_{DD}	V

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Parameter	Symbol	Conditions	min	typ	max	Unit
Output low level voltage	V_{OL} (1)	SBCK, $\overline{WE}$, $\overline{RAS}$, $\overline{CAS}$, $\overline{OE}$, A0 to A7, DB0 to DB3, CDGM, TRANS0 to TRANS5, VSYNC, YS, $\overline{CSYNC}$, EFLG, FSX, FSC: I_O = 2 mA	V_{SS}		0.4	V
	V_{OL} (2)	DO: I_O = 5 mA	V_{SS}		0.75	V
Output off leakage current	I_{OFF}	DO, DB0 to DB3	–5		+5	µA
Built-in feedback resistance	R_X	XIN1, XIN2, 4FSC2, FSCIN		1		MΩ
8-bit D/A converter reference voltage	V_{REF}	VIDEO	2.40	2.45	2.50	V
8-bit D/A converter output resistance	R_{DA}	VIDEO		300		Ω
8-bit D/A converter output level	V_{DAC}	VIDEO: Figure 9				
Random read/write cycle time	t_{RC}	Figures 2 and 3	250			ns
Page mode cycle time	t_{PC}	Figures 4 and 5	130			ns
RAS access time	t_{RAC}	Figure 2			210	ns
CAS access time	t_{CAC}	Figures 2 and 4			10	ns
Output turn-off delay time	t_{OFF}	Figures 2 and 4			20	ns
RAS precharge time	t_{RP}	Figures 2, 3, 4, 5 and 6	100			ns
RAS pulse width	t_{RAS}	Figures 2, 3 and 6	120			ns
RAS pulse width (page mode)	t_{RASP}	Figures 4 and 5			18000	ns
RAS hold time	t_{RSH}	Figures 2, 3, 4 and 5	60			ns
CAS hold time	t_{CSH}	Figures 2 and 3	120			ns
CAS pulse width	t_{CAS}	Figures 2, 3, 4 and 5	60			ns
CAS precharge time	t_{CPN}	Figure 6	50			ns
CAS precharge time (page mode)	t_{CP}	Figures 4 and 5	50			ns
Row address setup time	t_{ASR}	Figures 2, 3, 4 and 5	100			ns
Row address hold time	t_{RAH}	Figures 2, 3, 4 and 5	50			ns
Column address setup time	t_{ASC}	Figures 2, 3, 4 and 5	0			ns
Column address hold time	t_{CAH}	Figures 2, 3, 4 and 5	50			ns
Read command setup time	t_{RCS}	Figure 2	150			ns
Read command hold time (referenced to CAS)	t_{RCH}	Figure 2	120			ns
Read command hold time (referenced to RAS)	t_{RRH}	Figure 2	120			ns
Write command setup time	t_{WCS}	Figure 3	100			ns
Write command hold time	t_{WCH}	Figure 3	50			ns
Write command pulse width	t_{WP}	Figure 3	150			ns
Write data setup time	t_{DS}	Figure 3	100			ns
Write data hold time	t_{DH}	Figure 3	100			ns
CAS setup time (CAS before RAS)	t_{CSR}	Figure 6	50			ns
CAS hold time (CAS before RAS)	t_{CHR}	Figure 6	50			ns
RAS precharge · CAS active time	t_{RPC}	Figure 6	50			ns
Video setup time	t_{VS}	Superimposition: Figure 7	20		25	ns
SBCK output delay time	t_{SD}	NTSC mode: Figure 8	4.74		5.03	µs
		PAL mode:	4.79		5.08	µs
SBCK cycle frequency	f_{SC}	NTSC mode: Figure 8		224		kHz
		PAL mode:		222		kHz
PW setup time	t_{PWS}	Figure 8	100			ns



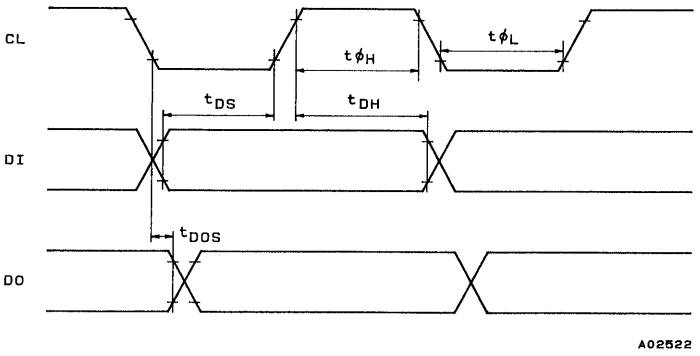


Figure 1 Microcontroller Interface Timing

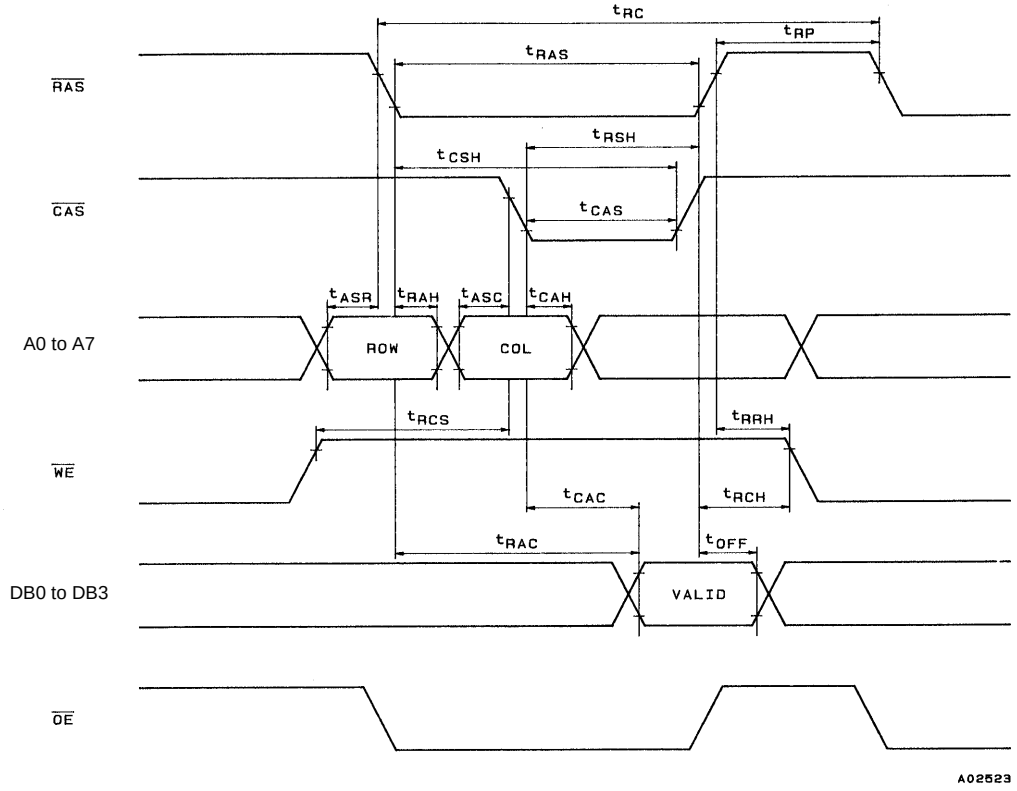


Figure 2 DRAM Read Cycle

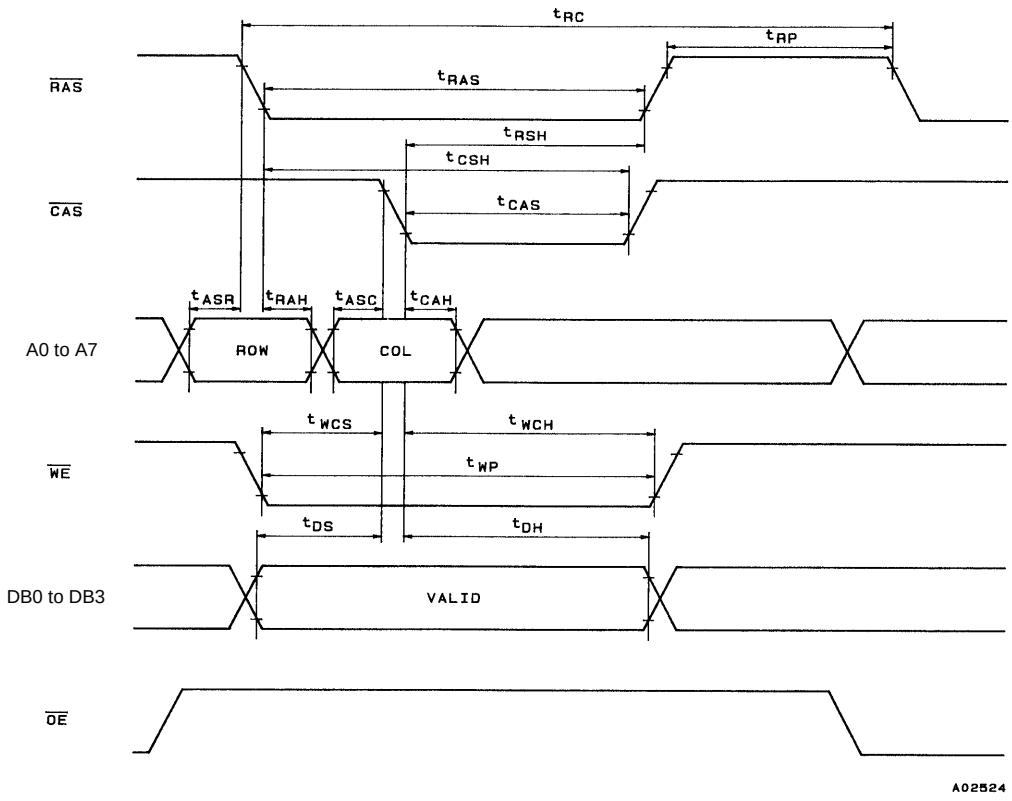


Figure 3 DRAM Early Write Cycle

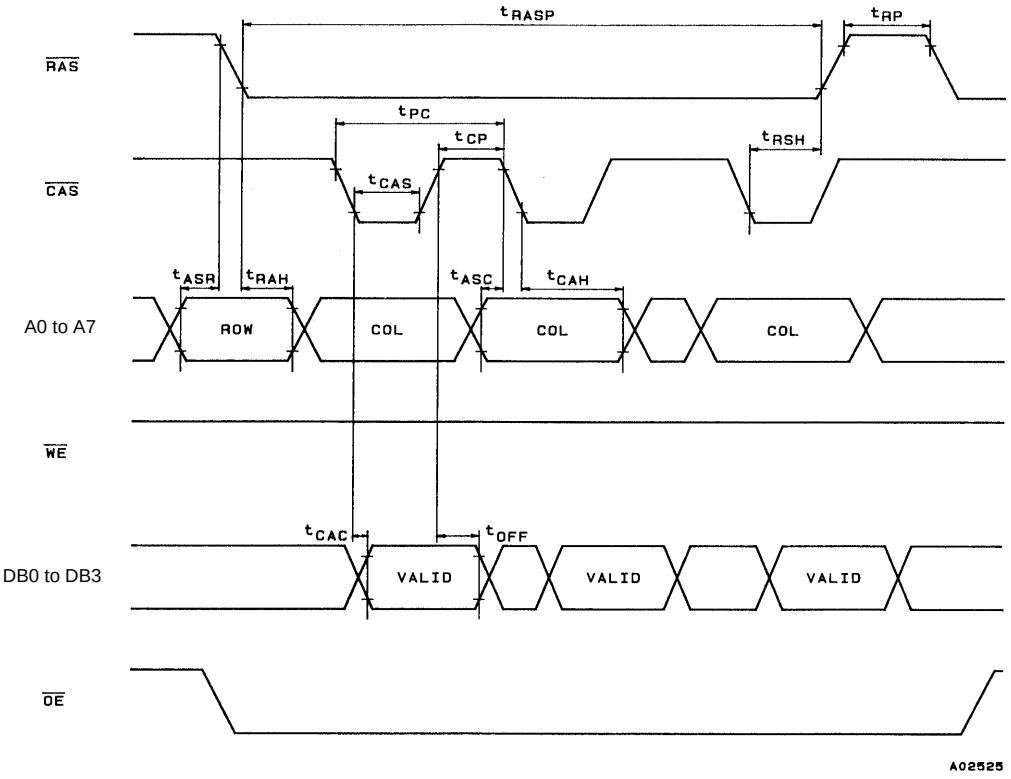


Figure 4 DRAM Page Mode Read Cycle

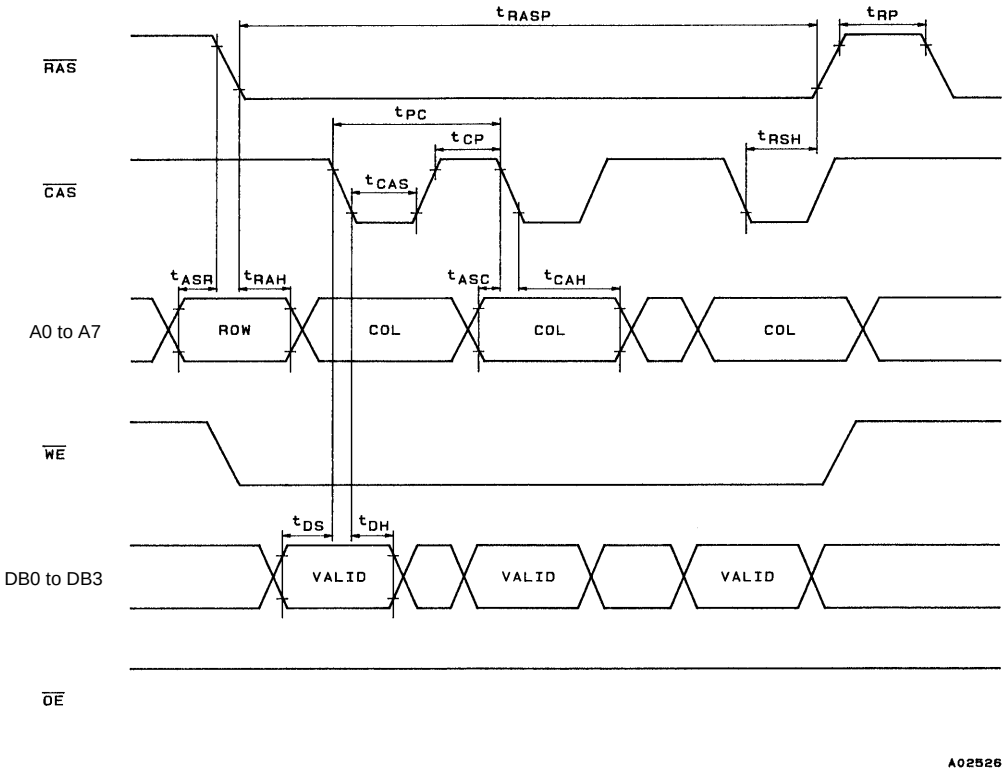


Figure 5 DRAM Page Mode Write Cycle

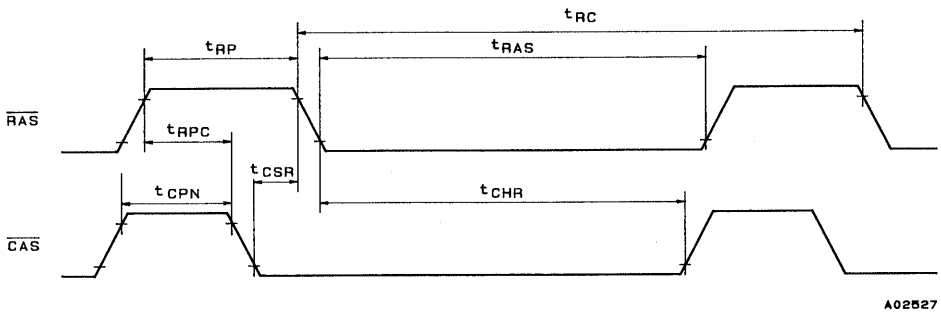


Figure 6 DRAM $\overline{\text{CAS}}$ before $\overline{\text{RAS}}$ Refresh Cycle

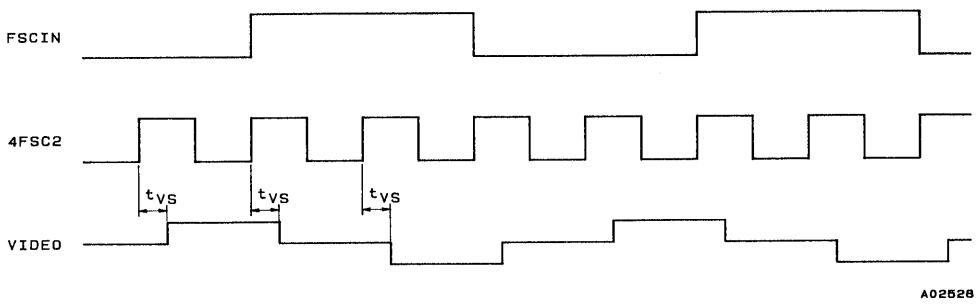
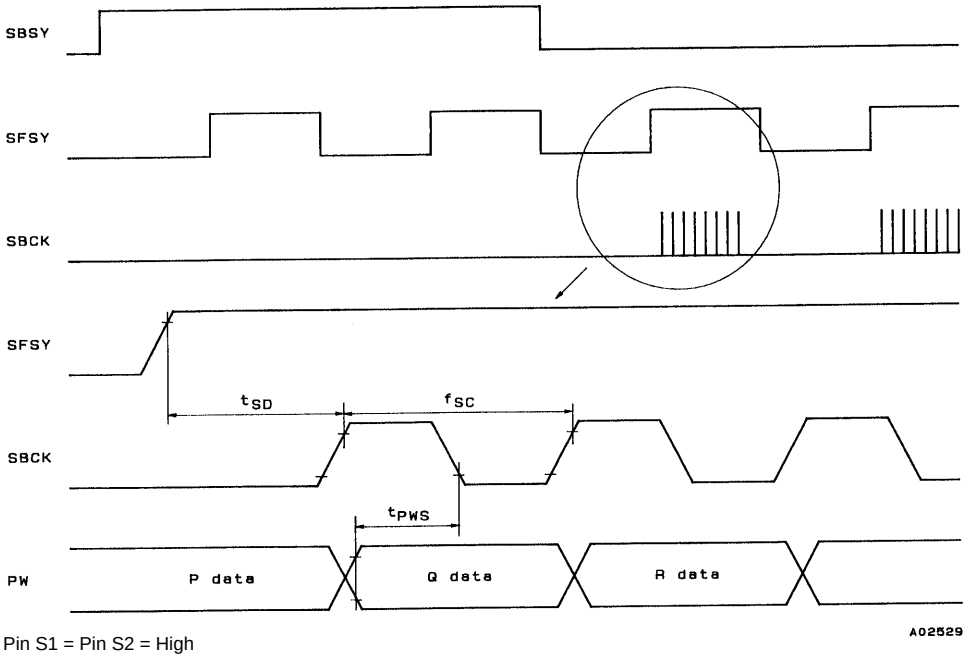


Figure 7 Phase Relationships in Superimposition Mode



Pin S1 = Pin S2 = High

Figure 8 Subcode Interface

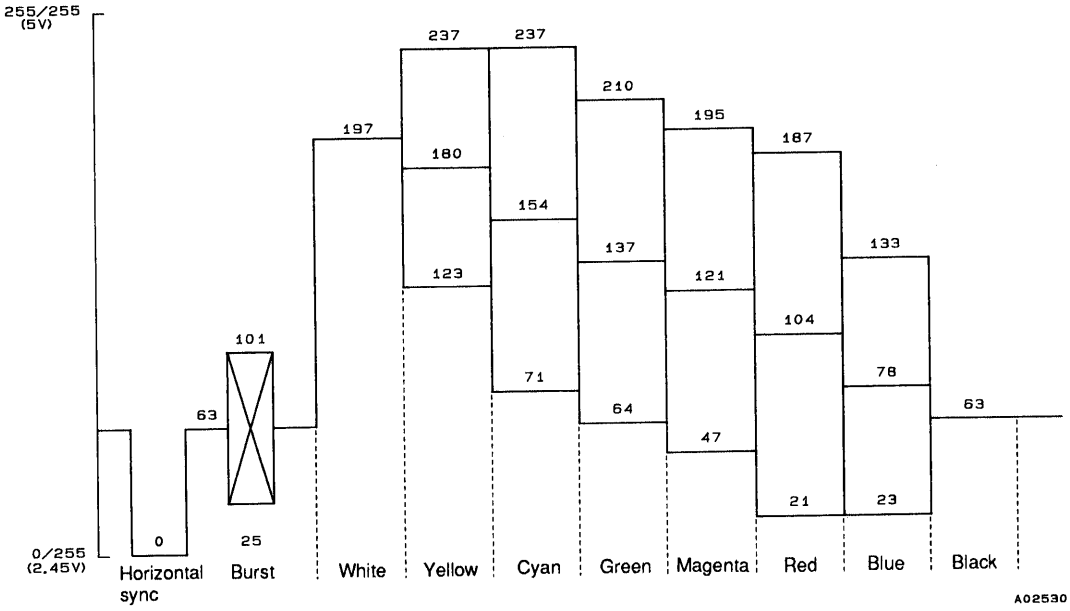


Figure 9 Composite Video 8-Bit Digital Values (Color Bar Output) at $V_{DD}2 = 5$ V

Pin Functions

Pin No.	Symbol	I/O	Function			
1	S1	I	CD DSP selection	S1	S2	CD DSP
				0	0	LC7861N/67
2	S2	I		1	0	LC7860K/63
				1	1	LC7868/69/681
3	SBCK	O	Subcode R to W readout clock			
4	SFSY	I	Subcode frame synchronization signal			
5	PW	I	Subcode R to W data			
6	SBSY	I	Subcode block synchronization signal			
7	$V_{DD}1$	—	Digital system power supply			
8	CE	I	Serial input or control pin during serial output			
9	DO	O	Serial data output (N-ch open drain)			
10	DI	I	Serial data input			
11	CL	I	Serial data I/O clock			
12	MUTE	I	Control signal that invalidates the subcode data			
13	$V_{SS}1$	—	Digital system ground			
14	$\overline{WE}$	O	DRAM control			
15	$\overline{RAS}$	O	DRAM control			
16	A0	O	DRAM address			
17	A1	O	DRAM address			
18	A2	O	DRAM address			
19	A3	O	DRAM address			
20	A4	O	DRAM address			
21	A5	O	DRAM address			
22	A6	O	DRAM address			
23	A7	O	DRAM address			
24	DB0	I/O	DRAM data			
25	$\overline{CAS}$	O	DRAM control			
26	DB1	I/O	DRAM data			
27	$\overline{OE}$	O	DRAM control			
28	DB2	I/O	DRAM data			
29	DB3	I/O	DRAM data			
30	CB	I	High: color bar output Low: normal mode (pull-down resistor built in)			
31	CDGM	O	Outputs a high level when a CD-G disk detected			
32	TRANS0	O	Transparency digital output			
33	TRANS1	O	Transparency digital output			
34	TRANS2	O	Transparency digital output			
35	TRANS3	O	Transparency digital output			
36	TRANS4	O	Transparency digital output			
37	TRANS5	O	Transparency digital output			
38	$V_{SS}2$	—	Composite video D/A converter ground			
39	$V_{DD}2$	—	Composite video D/A converter power supply			
40	BIAS	O	Ripple exclusion capacitor connection			
41	VIDEO	O	Composite video output (8-bit D/A converter output)			
42	TEST	I	Test pin. Must be tied low in normal operation (pull-down resistor built in)			
43	LINE	I	When pin NP2 is high: High: 263H, Low: 262H When pin NP2 is low: High: 312H, Low: 314H			
44	FSCIN	I	Subcarrier clock input (feedback resistor built in)			
45	VSYNC	O	Vertical synchronization signal output			
46	TEST1	I	Test pin. Must be tied low in normal operation (pull-down resistor built in)			
47	YS	O	Superimposition control output			
48	$\overline{CSYNC}$	O	Composite synchronization signal output			
49	4FSC2	I	Superimposition mode external clock input (feedback resistor built in)			
50	EFLG	O	Error state monitor			

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Pin No.	Symbol	I/O	Function
51	FSX	O	Error state monitor trigger
52	DEN	I	Disk information display enable pin — High: BGC, Low: Enable (pull-down resistor built in)
53	PALID	I	Superimposition PAL mode external control (pull-up resistor built in)
54	$\overline{\text{HRESET}}$	I	Horizontal timing external control
55	FSC	O	Subcarrier clock output — NTSC mode: 3.579545 MHz, PAL mode: 4.433619 MHz
56	$\overline{\text{VRESET}}$	I	Vertical timing external control
57	$\overline{\text{RESET}}$	I	Reset input
58	N/P1	I	NTSC/PAL selection — High: NTSC, Low: PAL (RGB encoder)
59	N/P2	I	NTSC/PAL selection — High: NTSC, Low: PAL (CD-G decoder)
60	SON	I	Superimposition on/off
61	XIN2	I	Crystal oscillator connection 17.734476 MHz (PAL)
62	XOUT2	O	Crystal oscillator connection 17.734476 MHz (PAL)
63	XIN1	I	Crystal oscillator connection 14.31818 MHz (NTSC)
64	XOUT1	O	Crystal oscillator connection 14.31818 MHz (NTSC)

CD-G Instructions

The LC7872E supports the following instructions that appear in the R to W subcodes as described in the CD Red Book.

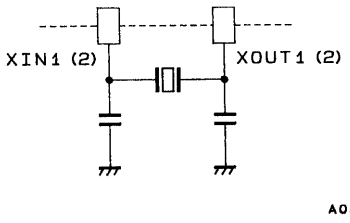
1. MODE = 0, ITEM = 0 ZERO mode
2. MODE = 1, ITEM = 0 LINE GRAPHICS mode
   - Write FONT instruction (4)
   - Write Scroll SCREEN instruction (12)
3. MODE = 1, ITEM = 1 TV-GRAPHICS mode
   - Preset MEMORY instruction (1)
   - Preset BORDER instruction (2)
   - Write FONT FOREGROUND/BACKGROUND instruction (6)
   - Scroll SCREEN with preset instruction (20)
   - Scroll SCREEN with Copy instruction (24)
   - Load CLUT Color-0...7 instruction (30)
   - Load CLUT Color-8...15 instruction (31)
   - EXCLUSIVE-OR FONT instruction (38)
   - Define Color Transparency instruction (28)

Pin Applications

1. Crystal Clock Oscillator; XIN1, XOUT1, XIN2, XOUT2, N/P1, N/P2, FSC, $\overline{\text{CSYNC}}$, LINE and VSYNC
   The LC7872E provides two crystal oscillator systems as follows.
   Pins XIN1 and XOUT1 are for use with a 14.31818 MHz crystal oscillator (NTSC)
   Pins XIN2 and XOUT2 are for use with a 17.734476 MHz crystal oscillator (PAL)
   Crystals can be connected to either crystal system 1 or 2 according to the application, or both systems can be used under the control of pins N/P1 and N/P2 to implement an application that supports both video standards. The N/P1 pin switches the LC7872E RGB encoder block between NTSC and PAL and the N/P2 pin switches the decoder block between NTSC and PAL. The FSC pin outputs a clock that is the crystal oscillator frequency divided by four. The $\overline{\text{CSYNC}}$ pin is the composite synchronization signal output and VSYNC is the vertical synchronization signal output. The LINE pin switches the number of lines on a screen.

   The table below lists the pin states in each mode.

XIN1, XOUT1	XIN2, XOUT2	N/P1	N/P2	Television system	FSC	LINE	$\overline{\text{CSYNC}}$
14.31818 MHz	*	High	High	NTSC/M	3.579545 MHz	H	16.71511323 ms
						L	16.65155767 ms
*	17.734476 MHz	Low	Low	PAL/GBIDH	4.433619 MHz	H	19.96788628 ms
						L	20.09588555 ms
14.30244 MHz	*	Low	High	PAL/M	3.575611 MHz	H	16.73350841 ms
						L	16.6698829 ms

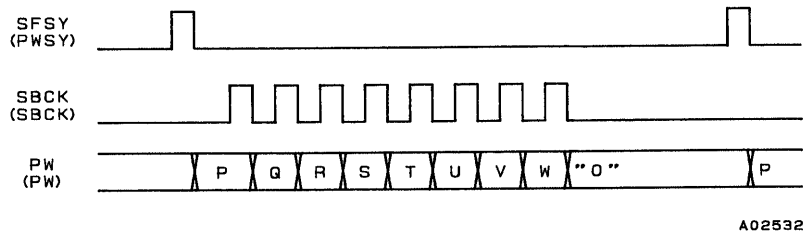


2. Subcode Interface; S1, S2, SBSY, SFSY, PW, SBCK and MUTE
   The LC7872E supports three interface modes under the control of pins S1 and S2. When the MUTE pin is set high, SBSY and PW input is disabled and SBCK output stops.

S1	Low	High	High
S2	Low	Low	High
Mode	LC7861N/67 interface	LC7860K/63 interface	LC7868/69/681 interface

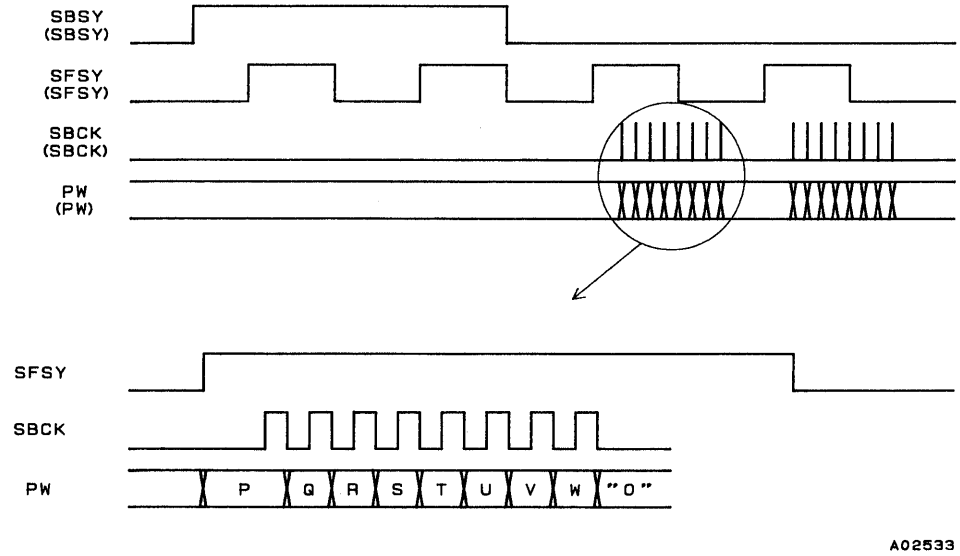
   The SBCK delivery condition is that SFSY be confirmed to be low about 2.2 µs after the SFSY falling edge in LC7860K/63 interface mode. In the other interface modes, the condition is that SFSY be confirmed to be high and SBSY be confirmed to be low about 2.2 µs after the SFSY rising edge.

   • LC7860 interface (Pin names in parentheses are LC7860 pins.)



Note: 1. PWSY will be high during the S0 and S1 periods.
2. The SBSY pin must be held low.

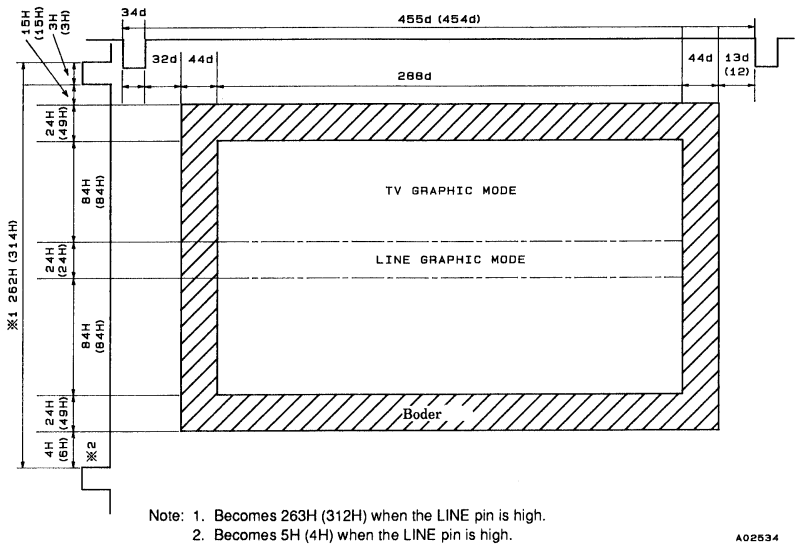
- LC7861N/67 interface (Pin names in parentheses are DSP pins.)



- LC7868/69/681 interface
  Identical to the LC7861N/67 interface except that the SBCK polarity is reversed (the shift occurs on the rising edge).

3. DRAM Interface; A0 to A7, DB0 to DB3, $\overline{RAS}$, $\overline{CAS}$, $\overline{WE}$, $\overline{OE}$
   The LC7872E uses an external 64-kword × 4-bit DRAM.

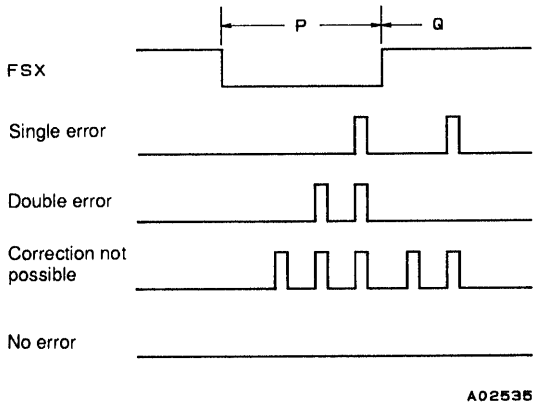
4. Display Format; DEN, N/P1, N/P2, $\overline{CSYNC}$, $\overline{VRESET}$, $\overline{HRESET}$, YS, VIDEO, PALID and TRANS0 to TRANS5
   - Data to which error detection and correction has been applied is encoded by the RGB encoder and the 8-bit D/A converter output is output from the VIDEO pin. This circuit handles both NTSC and PAL formats and either mode can be specified using the N/P pins. See item 1 for details on the pin states for the NTSC and PAL specifications.
   - The 4FSC2, FSCIN, YS, $\overline{VRESET}$, $\overline{HRESET}$, PALID and TRANS0 to TRANS5 pins are used in superimposition mode. The image may be disrupted if the $\overline{VRESET}$ and $\overline{HRESET}$ signals are not synchronized with 4FSC2.
     The PALID pin is controlled in PAL mode, and is used to match the LC7872E burst signal to the burst component of the external video signal. When this pin is high, the phase of the burst signal changes every horizontal period, and when this pin is low, the phase does not change.
     The YS pin outputs a control signal used to switch between an external video signal and the LC7872E video signal. The output conditions for this signal are set by the 2N byte command input registers 0, E, F, and G. The pins TRANS0 through TRANS5 output signals according to the define transparency instruction.
   - The DEN pin is a display control pin. The internal font data is output when DEN is low and the color data set up in the registers is used when DEN is high. The default state is blue.



5. CD Graphics Monitor; CDGM
   The CDGM pin goes high when the LC7872E receives any CD-G instruction. Since once this pin goes high it remains high as long as power is applied, using this pin requires a reset when the disk is changed.

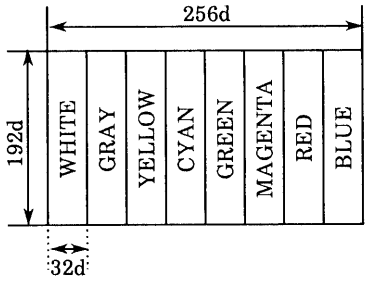
6. Video Output; VIDEO
   A composite video signal is output from the VIDEO pin. The output level of the 8-bit D/A converter is 2.5 Vp-p. Therefore only an external 75 Ω driver is required to acquire a 1 Vp-p rated output.

7. Error Flag Output; EFLG and FSX
   The result of the error detection process can be monitored from the EFLG pin.



The parity Q result can be monitored during periods when FSX is high.

8. Color Bar Output; CB
   The VIDEO pin outputs a color bar pattern when the CB pin is set high. The tables below describe this color bar pattern.

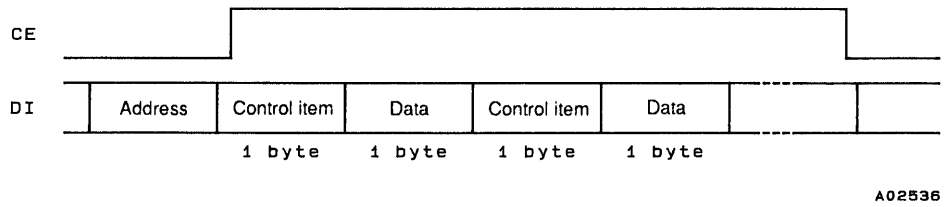


RGB Mixture Ratio (HEX)

Item	R	G	B
WHITE	F	F	F
GRAY	B	B	B
YELLOW	F	F	0
CYAN	0	F	F
GREEN	0	F	0
MAGENTA	F	0	F
RED	F	0	0
BLUE	0	0	F
BORDER (BLACK)	0	0	0

Microcontroller Interface (CCB Bus)

1. 2N byte input command



Address (F4h): lsb [0 0 1 0 1 1 1 1] msb
Control item: lsb [0 - - - A A A A] msb; Where AAAA is the register number.

Register 0 (mode setting)
Data: lsb [A B C D E F G H] msb; Default: [0 0 0 0 0 1 1 0]

A = VRAM/BG
- 0: Display the contents of VRAM
- 1: Display the background color (BGC)

B = TV/LINE
- 0: TV graphics mode
- 1: Line graphics mode

C = Disk command enable
- 0: Only disk commands are accepted.
- 1: Disk commands are ignored and only MGC is accepted.

D = Color bar on/off
- 0: Off
- 1: Color bar on

EFG = Comparison conditions in superimposition mode (only valid when SON = 1)
- EF = 00: Comparison not performed.
- 01: When the border color is not black, YS is set high (display) for section whose color does not match the border color and is set low (clear) otherwise.
- 11: YS is set high for sections that do not match the chroma key color, and is set low otherwise.
- G = 0: The whole screen is set low (clear) when the comparison condition does not hold for EF = 00 and EF = 01.
- G = 1: The whole screen is set high (display) when the comparison condition does not hold for EF = 00 and EF = 01.

H = INIT
- 0: Normal
- 1: Internal reset

On an internal reset the display screen is set to a blue background screen.

Register 1 (screen position adjustment)
Data: lsb [H H H H V V V V] msb; Default: [0 0 0 0 0 0 0 0]

H = horizontal direction. The value is specified as a two's complement value with left being the positive direction. Position is adjustable in two dot units from –16 to +14 dots from the center.

V = vertical direction. The value is specified as a two's complement value with up being the positive direction. Position is adjustable in two dot units from –16 to +14 dots from the center.

Register 2 (on/off settings for channels 0 to 7)
Data: lsb [C C C C C C C C] msb; Default: [1 1 0 0 0 0 0 0]

C = channel 0 to 7
- 0: off
- 1: on

Register 3 (on/off settings for channels 8 to 15)
Data: lsb [C C C C C C C C] msb; Default: [0 0 0 0 0 0 0 0]
C = channel 8 to 15
0: off
1: on

Register 4 (BGC R and G setting)
Data: lsb [R R R R G G G G] msb; Default: [0 0 0 0 0 0 0 0]

Register 5 (BGC B setting)
Data: lsb [B B B B - - - -] msb; Default: [0 1 0 1 - - - -]

Register 6 (chroma key color R and G settings)
Data: lsb [R R R R G G G G] msb; Default: [0 0 0 0 0 0 0 0]

Register 7 (chroma key color B setting)
Data: lsb [B B B B - - - -] msb; Default: [0 0 0 0 - - - -]

Register 8 (burst phase setting, only valid when SON = 1)
Data: lsb [F F - - - - - P] msb; Default: [0 0 - - - - - 0]

Register 9 (YS and TRANS output timing)
Data: lsb [T T T - - - - -] msb; Default: [0 0 1 - - - - -]
T = phase setting. The phase difference between YS and TRANS (the digital output) and the video signal can be set to one of 8 levels from 0 to 7 in units of single 4FSC clock cycles. At a value of 4 the phase is identical to that of the VIDEO pin.

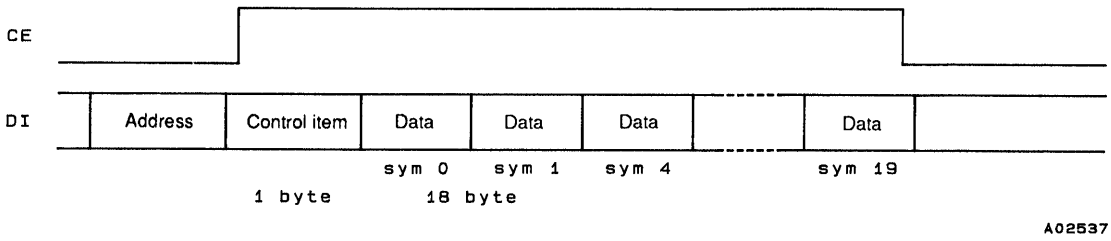
Register 10 (External synchronization on/off, test mode)
Data: lsb [T T T - - Y S R] msb; Default: [0 0 0 - - - 0 0]
T = test mode setting
R = 0: Only the display area is moved
1: Motion also includes the border area (only left/right motion supported)
S = 0: Normal
1: Initializes the TLUT contents to all 0.*
Y = 0: Resets HRESET and VRESET when an external clock is used (SON = 1)
1: Resets VRESET when an external clock is used (SON = 1) (HRESET is not required)
Note: * In this state the define transparency command will not be accepted. (Return the system to the S = 0 state.)

Register 11 (subtitle scrolling, vertical)
Data: lsb [V V V V V - - -] msb; Default: [0 0 0 0 0 - - -]
This setting allows the subtitle screen display position to be scrolled in font height units.
V = vertical (up) scrolling distance (0 to 17 font height units)

Register 12 (subtitle scrolling, horizontal)
Data: lsb [H H H H H H - -] msb; Default: [0 0 0 0 0 0 - -]
This setting allows the subtitle screen display position to be scrolled in font width units.
H = horizontal (left) scrolling distance (0 to 49 font width units)

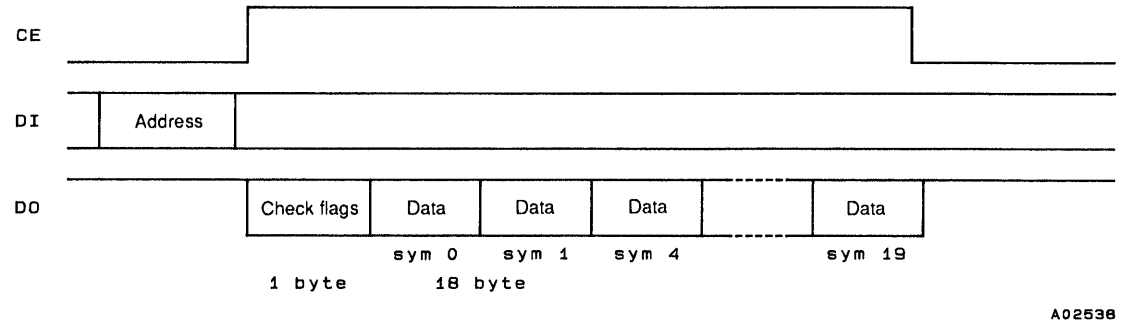
Register 13 (TRANS setting, only valid when SON = 1)
Data: lsb [B B B B B B - P] msb; Default: [0 0 0 0 0 0 - 1]
P = 1: Enables the TRANS setting.
0: Invalid
(The whole screen is displayed and burst goes to the CDG side.)
B = the BGC TRANS value

2. 19-byte input command (MGC write)



Address (F4h): lsb [0 0 1 0 1 1 1 1] msb
Control item: lsb [1 - - - - - - -] msb
Data: lsb [- - W V U T S R] msb; R to W is the subcode input.
This command is executed on the CE falling edge.

3. 19-byte output command (packed data readout)

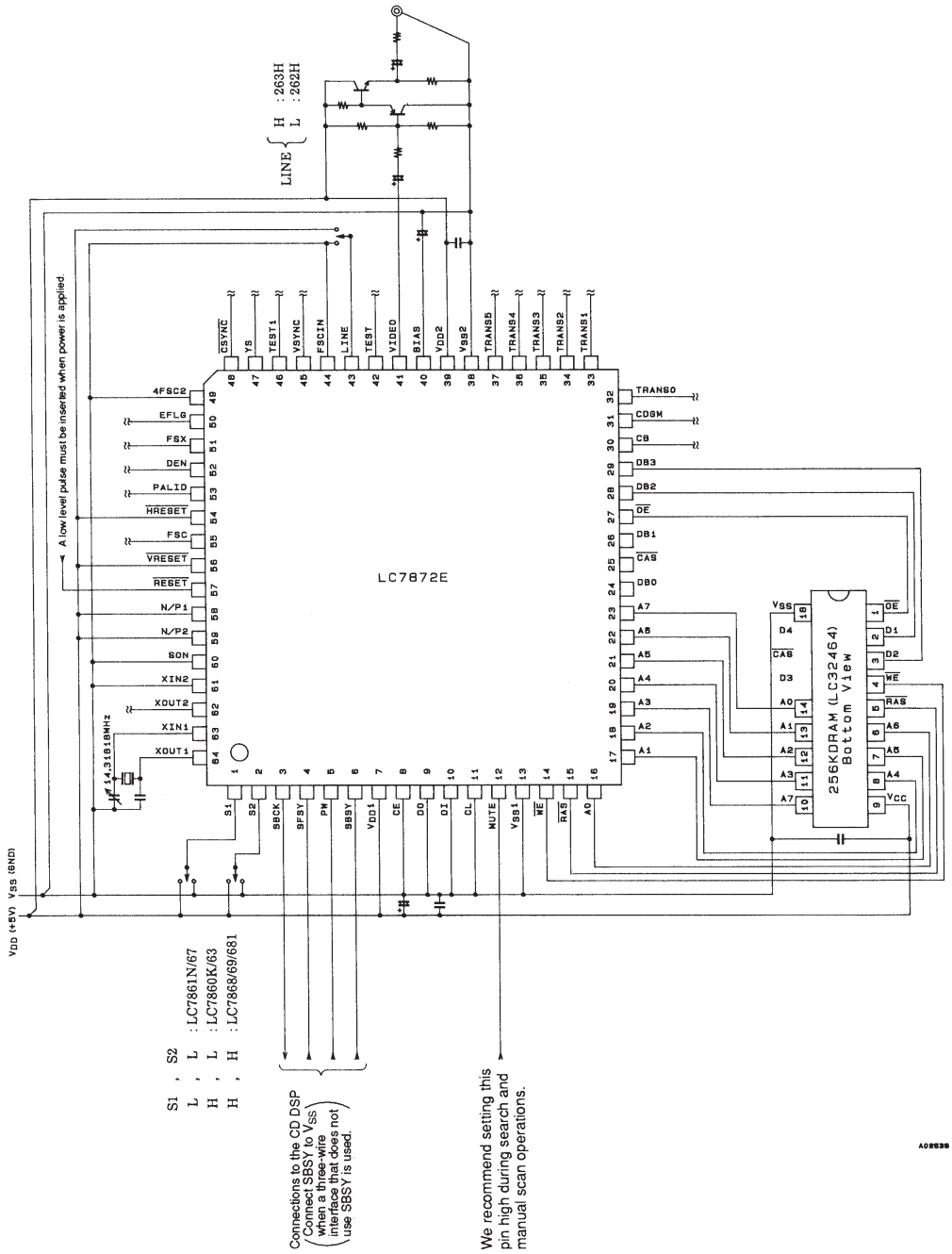


Address (F5h): lsb [1 0 1 0 1 1 1 1] msb
Check flags: lsb [A B C D Q Q P P] msb
Data: lsb [- - W V U T S R] msb

A = Set to 1 when the following 18 bytes are guaranteed and furthermore this is the first data item read out. (The readout operation must be completed within 1.1 ms.)
B = 0: Command execution in progress
1: Command wait state
C = VBLANK:Set to 1 during the vertical blanking period
D = Disk identifier flag
0: CD
1: CD-G
Q = QF0 and QF1 (Q error correction flags)
P = PF0 and PF1 (P error correction flags)

Note that when it is not necessary to read out all 19 bytes, the readout can be interrupted at any point in byte units. (In particular, this command can be used to read out only the check flags.)

NTSC Application Circuit Using the LC7872E



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